Refine Search

Search Results -

Terms	Documents
L16	0

Database:

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Search: L17

[Refine Search]

[Recall Text] [Clear] [Interrupt]

Search History

DATE: Friday, November 05, 2004   Printable Copy   Create Case

Set Name side by side	Query	Hit Count	Set Name result set
	DB=TDBD; PLUR=YES; OP=OR		
L17	L16	0	L17
	DB=DWPI; PLUR=YES; OP OR		
L16	L15	0	L16
	DB=JPAB; PLUR=YES; OP OR		
L15	L14	0	L15
	DB=EPAB; PLUR=YES; OP OR		
L14	L13	0	L14
	DB=USOC; PLUR=YES; OP OR		
L13	L12	0	L13
	DB=PGPB; PLUR=YES; OP OR		
L12	L11	0	L12
	DB=USPT; PLUR=YES; OP R		
L11	L10 and (via or opening	12	L11

h   e b   b cg b   e e ch

L10	L9 and (insulat$5 near s·ostrate)	16	L10
L9	(die or chip) same (((co· uct$4) near·· ("side surface" or "side surfaces")) and ("upper surface" or ' ower surface"))	69	L9
L8	L7	5	L8
L7	L6 and ("conductive ep· xy" near7 (conductor$ or metal))	5	L7
L6	L5 and ((via or opening) near7 substrate)	47	L6
L5	("conductive epoxy" NEAR6 (CHIP OR DIE)) and "lead frame"	197	L5
L4	L3 and ((insulat$5 neal ·bstrate) same "metal foil") and (chip or die)	0	L4
L3	"conductive ep· xy" and ·ad frame"	563	L3
L2	5780928 and "co· ducti· · epoxy"	0	L2
L1	5780928	18	L1

END OF SEARCH HISTORY

h   e b   b cg b   · e ch